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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: TIEN-JEN CHANG, ET AL.)
Serial No.: 10/707,047) Group Art Unit: 1753
Filed: November 18, 2003) Examiner: Van, L.
For: METHOD FOR SELECTIVE ELECTRO-)
PLATING OF SEMICONDUCTOR) Confirmation No.: 1046
DEVICE I/O PADS USING A)
TITANIUM-TUNGSTEN SEED LAYER)

AMENDMENT AFTER FINAL

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

*Entered per
PCE filed
4/10/06*

In response to the Final Office Action mailed February 27, 2006, please amend
the Application as follows: